



Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at
www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

FMS6404

Precision Composite Video Output with Sound Trap and Group Delay Compensation

Features

- 7.6MHz 5th-Order Composite Video Filter
- 14dB Notch at 4.425MHz to 4.6MHz for Sound Trap Capable of Handling Stereo
- 50dB Stopband Attenuation at 27MHz on CV Output
- > 0.5dB Flatness to 4.2MHz on CV Output
- Equalizer and Notch Filter for Driving RF Modulator with Group Delay of -180ns
- No External Frequency Selection Components or Clocks
- < 5ns Group Delay on CV Output
- AC-Coupled Input
- AC- or DC-Coupled Output
- Capable of PAL Frequency for CV
- Continuous Time Low-Pass Filters
- <1.4% Differential Gain with 0.7° Differential Phase on CV Channel
- Integrated DC Restore Circuitry with Low Tilt

Applications

- Cable Set-Top Boxes
- Satellite Set-Top Boxes
- DVD Players

Description

The FMS6404 is a single composite video 5th-order Butterworth low-pass video filter optimized for minimum overshoot and flat group delay. The device contains an audio trap that removes video information in a spectral location of the subsequent RF audio carrier. The group delay compensation circuit pre-distorts the signal to compensate for the inherent receiver intermediate frequency (IF) filter's group delay distortion.

In a typical application, the composite video from the DAC is AC coupled into the filter. The CV input has DC-restore circuitry to clamp the DC input levels during video synchronization. The clamp pulse is derived from the CV channel.

All outputs are capable of driving 2V_{PP}, AC- or DC-coupled, into either a single or dual video load. A single video load consists of a series 75Ω impedance matching resistor connected to a terminated 75Ω line. This presents a total of 150Ω of loading to the part. A dual load would be two of these in parallel, which presents a total of 75Ω to the part. The gain of the CV signal is 6dB with 1V_{PP} input levels. All video channels are clamped during synchronization to establish the appropriate output voltage reference levels.

Related Resources

- [AN-6024 – FMS6xxx Product Series Understanding Analog Video Signal Clamps, Bias, DC Restore, and AC or DC coupling Methods](#)
- [AN-6041 – PCB Layout Considerations for Video Filter / Drivers](#)

Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FMS6404CSX	-40°C to +70°C	8-Lead, Small-Outline Integrated Circuit (SOIC), JEDEC MS-012, .150" Narrow Body	2500 Units per Reel

Block Diagram

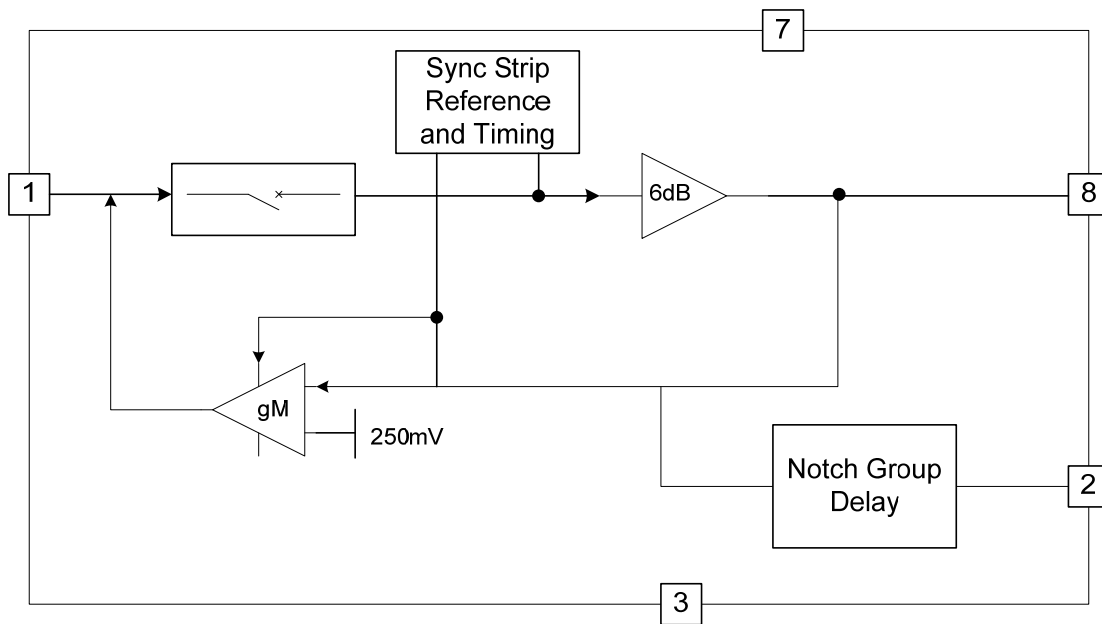


Figure 1. Block Diagram

Pin Configuration

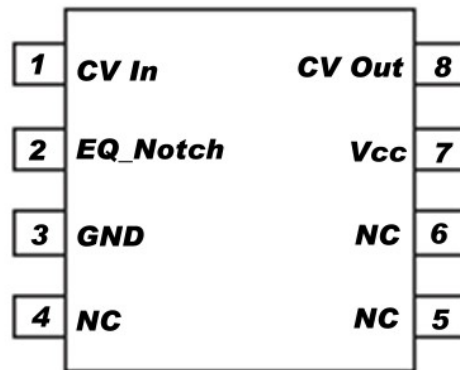


Figure 2. Pin Assignments (Top View)

Pin Definitions

Pin#	Name	Type	Description
1	CV In	Input	Composite video input
2	EQ Notch	Output	Composite video output to RF modulator
3	GND	Power	Device ground connection
4	NC	NA	No connection
5	NC	NA	No connection
6	NC	NA	No connection
7	Vcc	Power	Device power connection
8	CV Out	Output	Composite video output

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	DC Supply Voltage	-0.3	6.0	V
V _{IO}	Analog and Digital I/O	-0.3	V _{CC} +0.3	V
V _{OUT}	Maximum Output Current, Do Not Exceed		100	mA

Electrostatic Discharge Information

Symbol	Parameter	Min.	Unit
ESD	Human Body Model, JESD22-A114	8	kV
	Charged Device Model, JESD22-C101	2	

Reliability Information

Symbol	Parameter	Min.	Typ.	Max.	Unit
T _J	Junction Temperature			+150	°C
T _{STG}	Storage Temperature Range	-65		+150	°C
T _L	Lead Temperature (Soldering, 10 Seconds)			+300	°C
□ _{JA}	Thermal Resistance, JEDEC Standard, Multilayer Test Board, Still Air		90		°C/W

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Typ.	Max.	Unit
T _A	Operating Temperature Range	0		+70	°C
V _{CC}	Supply Voltage Range	4.75	5.00	5.25	V

DC Electrical Characteristics

T_A=25°C, V_{CC}=5.0V, R_S=37.5Ω, all inputs are AC-coupled with 0.1μF, and all outputs are AC coupled with 220μF into 150Ω load; unless otherwise noted.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
V _{CC}	Supply Voltage Range	V _S Range	4.75	5.00	5.25	V
I _{CC}	Quiescent Supply Current	V _S =+5.0V, No Load	50	70	90	mA
V _{IN}	Video Input Voltage Range	Referenced to GND if DC Coupled		1.4		V _{PP}
PSRR	Power Supply Rejection Ratio	DC		-50		dB
I _{SC}	Output Short Circuit Current	CV, EQ_NOTCH to GND		85		mA

AC Electrical Characteristics

$T_A=25^{\circ}\text{C}$, $V_{CC}=5.0\text{V}$, $R_S=37.5\Omega$, all inputs are AC-coupled with $0.1\mu\text{F}$, and all outputs are AC coupled with $220\mu\text{F}$ into 150Ω load, unless otherwise noted.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
AV_{CV}	Low Frequency Gain CV_{OUT}	at 400kHz	5.8	6.0	6.2	dB
AV_{EQ}	Low Frequency Gain (EQ_NOTCH)	at 400kHz	5.7	6.0	6.4	dB
CV_{sync}	CV_{OUT} Output Level (During Sync)	Sync Present on CV_{IN} (After 6dB Gain)		0.35	0.50	V
EQ_{sync}	EQ_NOTCH Output Level (During Sync)	Sync Present on CV_{IN} (After 6dB Gain)		0.35	0.50	V
t_{CLAMP}	Clamp Response Time CV_{OUT}	Settled to within 10mV		5		ms
f_{FLAT}	Gain Flatness to 4.2MHz CV_{OUT}		-0.5	0	0.5	dB
f_C	-3dB Bandwidth	CV_{OUT} Channel	6.7	7.6		MHz
f_{SB}	Stopband Attenuation CV_{OUT}	at 27MHz	40	50		dB
dG	Differential Gain	CV_{OUT}		1.4	3.0	%
dq	Differential Phase	CV_{OUT}		0.7	1.5	$^{\circ}$
THD	Output Distortion	$V_{OUT}=1.4V_{pp}$ at 3.58MHz		0.3		%
X_{TALK}	Crosstalk	$V_{OUT}=1.4V_{pp}$ at 3.58MHz		-50		dB
SNR	SNR CV_{OUT} Channel	NTC-7 Weighting 4.2MHz Low-Pass $V_{IN}=714\text{mV}$, $V_{OUT}=1.428V_{pp}/1.010V_{rms}$	70	75		dB
	SNR EQ_NOTCH Channel	NTC-7 Weighting 4.2MHz Low-Pass $V_{IN}=714\text{mV}$ $V_{OUT}=1.428V_{pp}/1.010V_{rms}$	65	70		dB
t_{pd}	Propagation Delay	at 400kHz		112		ns
GD	Group Delay CV_{OUT}	at 3.58MHz (Reference to 400kHz)	-5	0	5	ns
t_{CLGCV}	Chroma-Luma Gain CV_{OUT}	$f=3.58\text{MHz}$ (Reference to 400kHz)	98	100	102	%
t_{CLDCV}	Chroma-Luma Delay CV_{OUT}	$f=3.58\text{MHz}$ (Reference to 400kHz)	-10	0	10	ns
t_{GDEQ}	Group Delay EQ_NOTCH	$f=3.58\text{MHz}$ (Reference to 400kHz)	-195	-180	-165	ns
t_{CLGEQ}	Chroma-Luma Gain EQ_NOTCH	$f=3.58\text{MHz}$ (Reference to 400kHz)	95	100	105	%
t_{CLDEQ}	Chroma-Luma Delay EQ_NOTCH	$f=3.58\text{MHz}$ (Reference to 400kHz)	-195	-180	-165	ns
dG _{EQ}	Differential Gain	EQ_NOTCH Channel		0.3	1.0	%
dq _{EQ}	Differential Phase	EQ_NOTCH Channel		0.30	0.75	%
MCF	Modulator Channel Flatness	EQ_NOTCH from 400kHz to 3.75MHz	-0.5	0	0.5	dB
AV_{PK}	Gain Peaking	EQ_NOTCH from $>3.75\text{MHz}$ to 4.2MHz	-0.5	0	0.5	dB
Atten1	Notch Attenuation 1	EQ_NOTCH at 4.425MHz	14			dB
Atten2	Notch Attenuation 2	EQ_NOTCH at 4.5MHz	20			dB
Atten3	Notch Attenuation 3	EQ_NOTCH at 4.6MHz	14			dB
t_{PASS}	Passband Group Delay EQ_NOTCH	$f=400\text{kHz}$ to $f=3\text{MHz}$	-35		35	ns

Typical Performance Characteristics

Unless otherwise noted, $T_A = 25^\circ\text{C}$, $V_{CC} = 5.0\text{V}$, $R_s = 37.5\Omega$, and AC-coupled output into 150Ω load, CV_{OUT} .

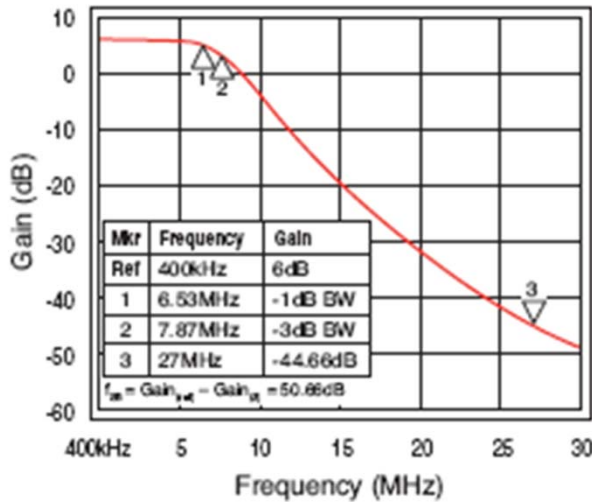


Figure 3. Frequency Response

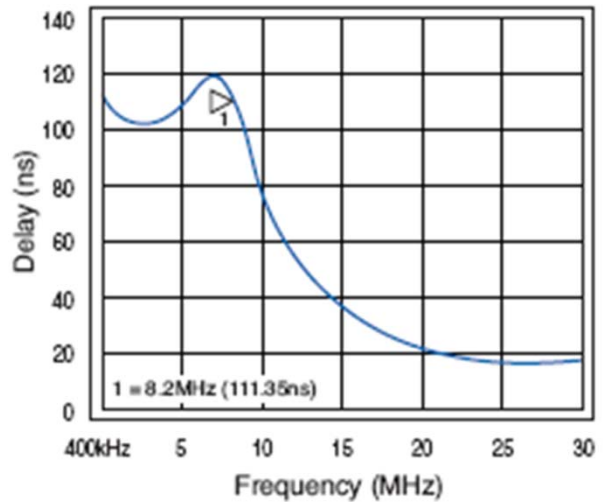


Figure 4. Group Delay vs. Frequency

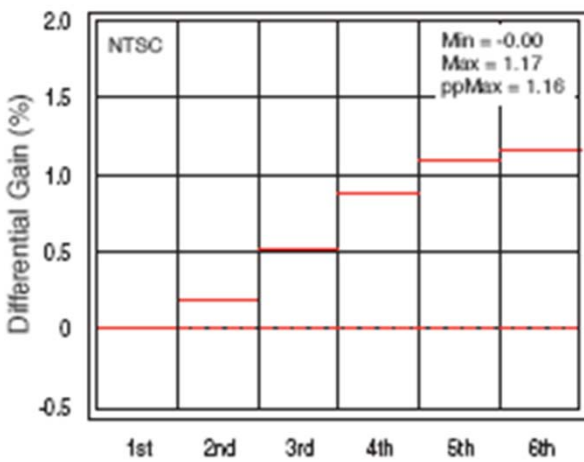


Figure 5. Differential Gain

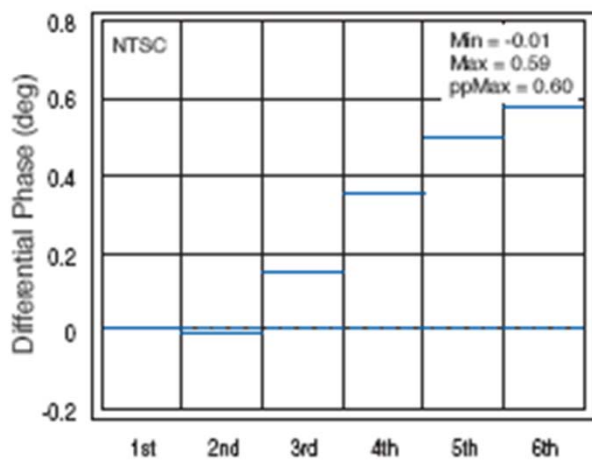


Figure 6. Differential Phase

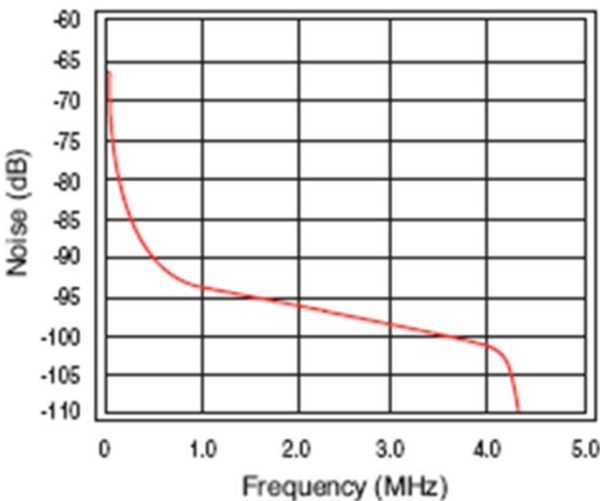


Figure 7. Noise vs. Frequency

Typical Performance Characteristics

Unless otherwise noted, $T_A = 25^\circ\text{C}$, $V_{CC} = 5.0\text{V}$, $R_s = 37.5\Omega$, and AC-coupled output into 150Ω load, CV_{OUT} .

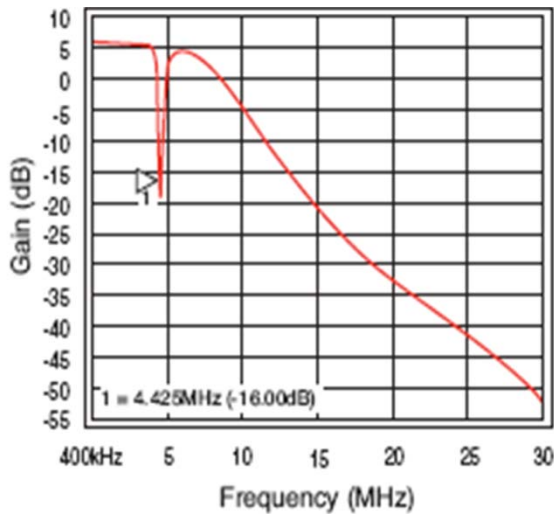


Figure 8. Modulator vs. Frequency Response

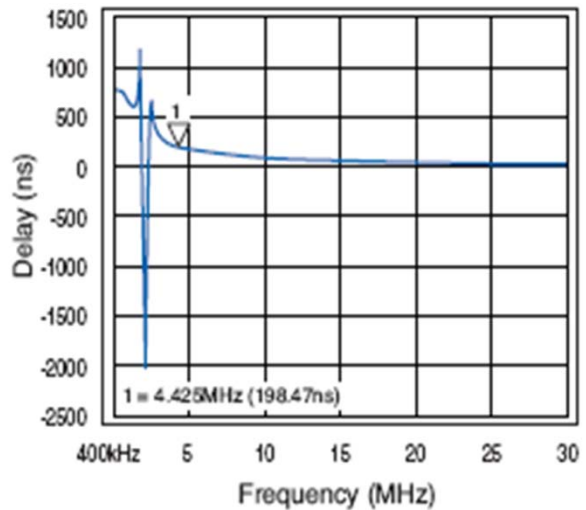


Figure 9. Delay Modulator Output

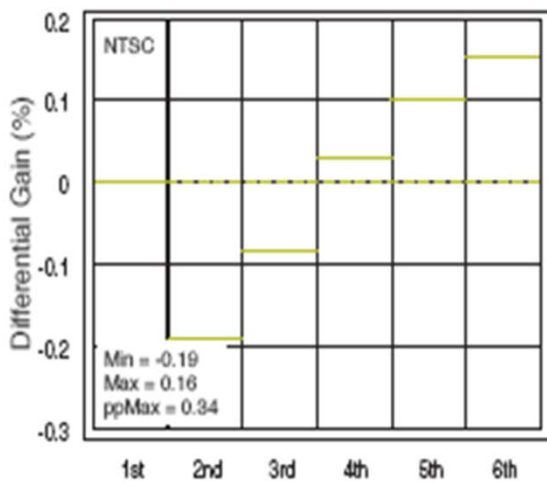


Figure 10. Differential Gain, MOD_{OUT}

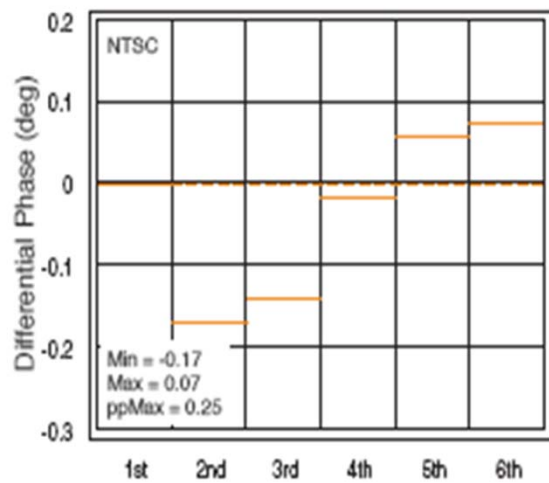


Figure 11. Differential Phase, MOD_{OUT}

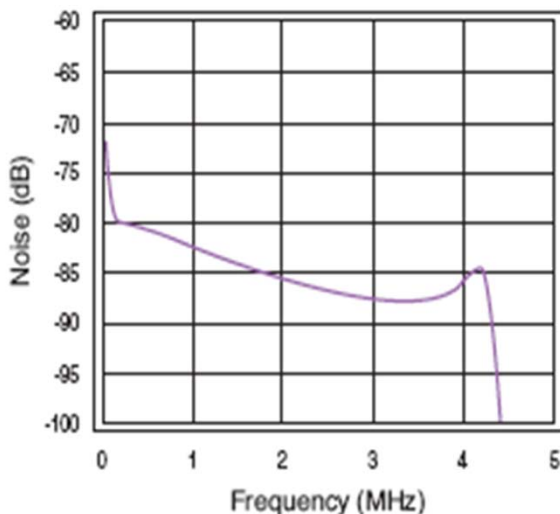


Figure 12. Noise vs. Frequency Modulator Channel

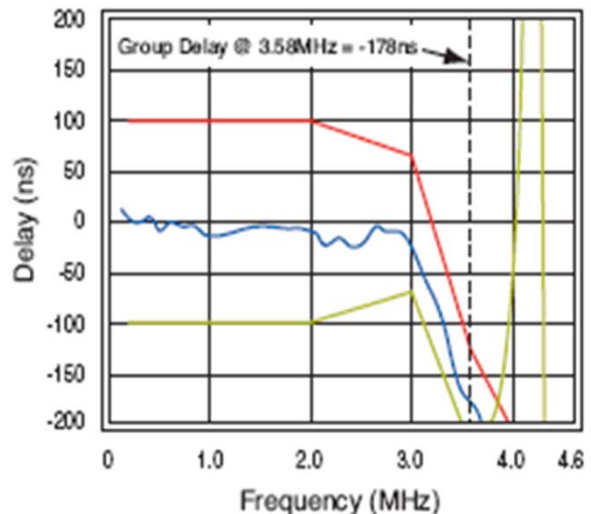


Figure 13. Group Delay vs. Frequency

Applications Information

Layout Considerations

General layout and supply bypassing play a major role in high-frequency performance and thermal characteristics. Fairchild offers a four-layer board with full power and ground planes board to guide layout and aid device evaluation. Following this layout configuration provides optimum performance and thermal characteristics for the device. For best results, follow the steps and recommended routing rules below.

Recommended Routing / Layout Rules

- Do not run analog and digital signals in parallel.
- Use separate analog and digital power planes to supply power.
- Traces must run on top of the ground plane.
- No trace should run over ground/power splits.
- Avoid routing at 90-degree angles.
- Minimize clock and video data trace length differences.
- Include 10 μ F and 0.1 μ F ceramic power supply bypass capacitors.
- Place the 0.1 μ F capacitor within 2.54mm (0.1in) of the device power pin.
- Place the 10 μ F capacitor within 19.05mm (0.75in) of the device power pin.
- For multi-layer boards, use a large ground plane to help dissipate heat.
- For two-layer boards, use a ground plane that extends beyond the device body at least 12.7mm (0.5in) on all sides. Include a metal paddle under the device on the top layer.
- Minimize all trace lengths to reduce series inductance.

Output Considerations

The outputs are DC offset from the input by 150mV; therefore, $V_{OUT} = 2 \cdot V_{IN} DC + 150mV$. This offset is required for optimal performance from the output driver and is held at the minimum value to decrease the standing DC current into the load. Since the FMS6404 has a 2 x (6dB) gain, the output is typically connected via a 75 Ω -series back-matching resistor, followed by the 75 Ω video cable. Due to the inherent divide-by-two of this configuration, the blanking level at the load of the video signal is always less than 1V. When AC-coupling the output, ensure that the coupling capacitor passes the lowest frequency content in the video signal and that line time distortion (video tilt) is kept as low as possible.

The selection of the coupling capacitor is a function of the subsequent circuit input impedance and the leakage current of the input being driven. To obtain the highest quality output video signal, the series termination resistor must be placed as close to the device output pin as possible. This greatly reduces the parasitic capacitance and inductance effect on the output driver. The distance from the device pin to the series termination resistor should be no greater than 2.54mm (0.1in).

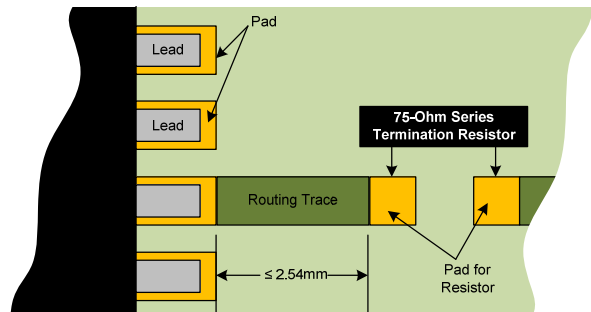


Figure 14. Termination Resistor Placement

Thermal Considerations

Since the interior of most systems, such as set-top boxes, TVs, and DVD players; is at +70°C; consideration must be given to providing an adequate heat sink for the device package for maximum heat dissipation. When designing a system board, determine how much power each device dissipates. Ensure that devices of high power are not placed in the same location, such as directly above (top plane) or below (bottom plane) each other on the PCB.

PCB Thermal Layout Considerations

- Understand the system power requirements and environmental conditions.
- Maximize thermal performance of the PCB.
- Consider using 70 μ m of copper for high-power designs.
- Make the PCB as thin as possible by reducing FR4 thickness.
- Use vias in power pad to tie adjacent layers together.
- Remember that baseline temperature is a function of board area, not copper thickness.
- Modeling techniques provide a first-order approximation.

Physical Dimensions

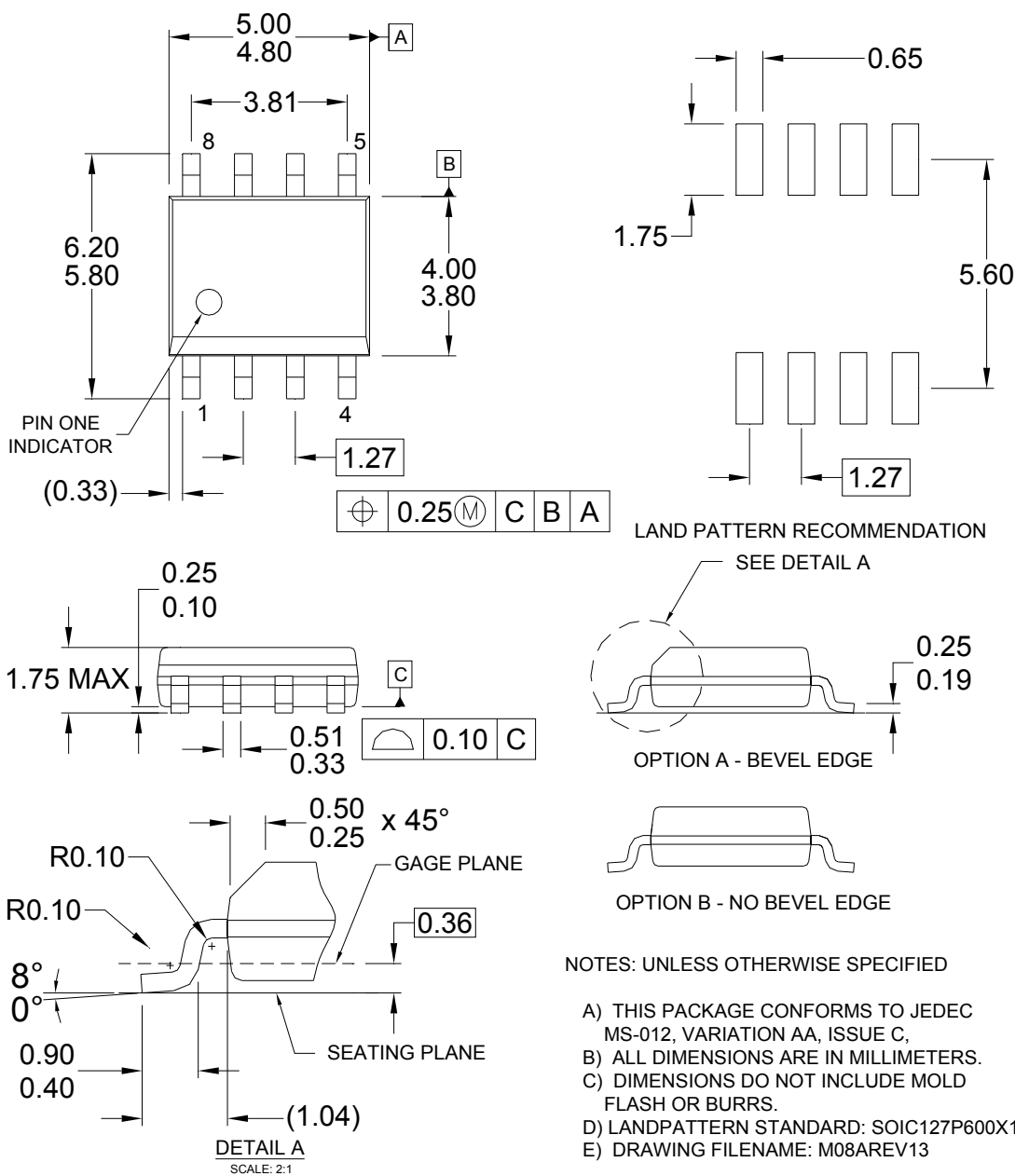


Figure 15. 8-Lead, Small-Outline Integrated Circuit (SOIC), JEDEC MS-012, .150" Narrow Body

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:
<http://www.fairchildsemi.com/packaging/>.



TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

- | | | | |
|--|---|---|---|
| 2Cool™ | FPS™ | PDP SPM™ | The Power Franchise® |
| AccuPower™ | F-PFS™ | Power-SPM™ | the power franchise |
| Auto-SPM™ | FRFET® | PowerTrench® | TinyBoost™ |
| AX-CAP™* | Global Power Resource SM | PowerXS™ | TinyBuck™ |
| BitSiC™ | Green FPS™ | Programmable Active Droop™ | TinyCalc™ |
| Build it Now™ | Green FPS™ e-Series™ | QFET® | TinyLogic® |
| CorePLUS™ | Gmax™ | QST™ | TINYOPTO™ |
| CorePOWER™ | GTO™ | Quiet Series™ | TinyPower™ |
| CROSSVOLT™ | IntelliMAX™ | RapidConfigure™ | TinyPWM™ |
| CTL™ | ISOPLANAR™ |  ™ | TinyWire™ |
| Current Transfer Logic™ | Making Small Speakers Sound Louder and Better™ | Saving our world, 1mV/W/KV at a time™ | TransiC™ |
| DEUXPEED® | MegaBuck™ | SignalVise™ | TriFault Detect™ |
| Dual Cool™ | MICROCOUPLER™ | SmartMax™ | TRUECURRENT®* |
| EcoSPARK® | MicroFET™ | SMART START™ | µSerDes™ |
| EfficientMax™ | MicroPak™ | Solutions for Your Success™ |  |
| ESBC™ | MicroPak2™ | SPM® | UHC® |
|  Fairchild® | MillerDrive™ | STEALTH™ | Ultra FRFET™ |
| Fairchild Semiconductor® | MotionMax™ | SuperFET® | UniFET™ |
| FACT Quiet Series™ | Motion-SPM™ | SuperSOT™3 | VX™ |
| FACT® | mWSaver™ | SuperSOT™6 | VisualMax™ |
| FAST® | OptoHIT™ | SuperSOT™8 | VoltagePlus™ |
| FastvCore™ | OPTOLOGIC® | SupreMOS® | XS™ |
| FETBench™ | OPTOPLANAR® | SyncFET™ | |
| FlashWriter®* |  | Sync-Lock™ | |

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I58

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com
Order Literature: <http://www.onsemi.com/orderlit>
For additional information, please contact your local
Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[ON Semiconductor:](#)

[FMS6404CSX](#)



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.